



PATENT  
Atty. Dkt. No. AMAT/6228/CMP/ECPI/RKK

1753

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
Bajaj, et al.

Serial No.: 10/074,141

Confirmation No.: 6612

Filed: February 11, 2002

For: Additives for Electroplating  
Solution

Group Art Unit: 1753

Examiner: Edna Wong

#5/A  
w.m.  
9/14/03  
RECEIVED  
SEP 17 2003  
TC 1706

Mail Stop Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATE OF MAILING 37 CFR 1.8	
I hereby certify that this correspondence is being deposited on September 9, 2003, with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.	
9/9/03 Date	<i>Kent Z. Parker</i> Signature

**RESPONSE TO OFFICE ACTION DATED JUNE 9, 2003**

In response to the Office Action dated June 9, 2003, having a shortened statutory period for response set to expire on September 9, 2003, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no fee is due in conjunction with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/AMAT/6228/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper. **Remarks/Arguments** begin on page 13 of this paper.